# WIECH

### 12W, 3.5 - 4.0 GHz LDMOS MMIC Amplifier

Product datasheet

#### **Description**

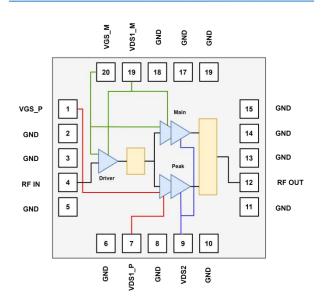
The H8G3540M12P is a LDMOS MMIC Integrated Asymmetrical Doherty based on 3-Stage with 12W saturated output power covering frequency range from 3.5 to 4.0 GHz.

The amplifier is 50  $\Omega$  Input/Output matched with a small compact footprint 7x7 mm which makes it ideal for integration.

20 Pin LGA 7x7 mm Plastic Package



#### **Block Diagram**



H8G3540M12P Block Diagram

#### **Features**

Operating Frequency Range: 3.5 to 4.0 GHz

Operating Drain Voltage: +28V

• Saturation Output Power: 12W

• 50 Ω Input/Output matched

• Integrated Input Divider

• Integrated Output Combiner

 Integrated Asymmetrical Doherty Final Stage

• High Efficiency: 30.6%@3.5GHz, WCDMA

High Gain: 34.7dB@3.5 GHz, WCDMA

Small footprint package: LGA 7x7 mm

#### **Applications**

- 3GPP 5G NR FR1 n77/78 and 4G-LTE band B42/43
- Power Amplifier for Small Cells
- Driver Amplifier for Micro and Macro Base Stations
- Active Antenna Array for 5G mMIMO
- Repeaters/DAS
- Mobile Infrastructure

### **Ordering Information**

Part Number	Description
H8G3540M12P	Reel Package
H8G3540M12PEVB	3.5 to 4.0 GHz EVB



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#### **RF Characteristics (Pulsed CW)**

Freq (GHz)	P3dB (dBm)	Gain (dB)	Eff (%)	IRL (dB)
3.5	41.4	34.7	30.4	12.1
3.65	41.4	34.8	30.5	23.1
3.8	41.0	34.0	29.2	15.6
4.0	40.8	31.5	27.0	12.6

Test conditions unless otherwise noted: 25 °C, VDD = +28Vdc, IDQ = 45 mA, Vgsp = Vgsm-0.5V, Pulse Width = 100 us, Duty Cycle = 10% test on WATECH Application Board

#### **RF Characteristics (WCDMA)**

Freq (GHz)	Gain (dB)	Eff (%)	IRL (dB)	ACPR* @5MHz (dBc)	ACPR* @10MHz (dBc)
3.5	34.7	30.6	12.5	-27.9	-41.5
3.65	34.4	30.8	21.8	-28.5	-43.0
3.8	33.6	30.1	15.5	-29.6	-44.6
4.0	31.0	27.2	12.3	-30.2	-42.7

Test conditions unless otherwise noted: 25 °C, VDD=+28Vdc, IDQ=45 mA, Vgsp=Vgsm-0.5V, PAVG=32 dBm 1C-WCDMA 5MHz Signal, 7.6 dB PAR @ 0.01% CCDF test on WATECH Application Board \*Uncorrected DPD

### **Absolute Maximum Ratings**

Parameter	Range/Value	Unit
Drain voltage (VDSS)	-0.5 to +65	V
Gate voltage (V <sub>GS</sub> )	-5 to +10	V
Drain voltage (VDD)	0 to +28	V
Storage Temperature (Tstg)	-55 to +150	°C
Case Temperature (Tc)	-40 to +125	°C
Junction Temperature (T <sub>J</sub> )	-40 to +175	°C



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### **Electrical Specification**

#### **DC Characteristics**

Parameter	Conditions	Min	Тур	Max	Unit
Breakdown Voltage V(BR)DSS	Vgs=0V, Ids=100uA	65	-	-	V
Gate-Source Threshold Voltage V <sub>GS(th)</sub>	Vgs=Vds, Ids=5.2uA	1.2	-	1.8	V
Drain Leakage Current loss	Vgs=0V, Vds=28V	-	-	0.5	uA
Gate Leakage Current IGSS	Vgs=5V, Vds=0V	-	-	0.05	uA

### **RF Characteristics (Pulsed CW)**

Parameter	Freq (GHz)	Min	Тур.	Max	Unit
P3dB	3.45	40	41.1	-	dBm
	3.65	40	41.4	-	dBm
	4.0	39.7	40.7	-	dBm

Test conditions unless otherwise noted: 25 °C, VDD = +28Vdc, IDQ = 45 mA, Vgsp = Vgsm-0.5V, Pulse Width = 100 us, Duty Cycle = 10% test on WATECH Production Board

#### **RF Characteristics (WCDMA)**

Parameter	Conditions	Min	Freq1	Max	Unit
Frequency		3.45			
Gain	Pavg = 32 dBm	31.5	34	-	dB
Eff	Pavg = 32 dBm	26	28.5	-	%
IRL	Pavg = 32 dBm	-	-	10	dB
ACPR@5MHz	D 22 dD		20	25	dD.
(Uncorrected)	Pavg = 32 dBm	-	-28	-25	dBc

Parameter	Conditions	Min	Freq1	Max	Unit
Frequency	3.65			GHz	
Gain	Pavg = 32 dBm	31.5	34	-	dB
Eff	Pavg = 32 dBm	28.5	31	-	%
IRL	Pavg = 32 dBm	-	-	10	dB
ACPR@5MHz	D 22 dD		20	25	dD.a
(Uncorrected)	Pavg = 32 dBm	-	-28	-25	dBc



### 12W, 3.5 - 4.0 GHz LDMOS MMIC Amplifier

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Parameter	Conditions	Min	Freq1	Max	Unit
Frequency		4.0			GHz
Gain	Pavg = 32 dBm	28.5	31	-	dB
Eff	Pavg = 32 dBm	26	28.5	-	%
IRL	Pavg = 32 dBm	-	-	10	dB
ACPR@5MHz	D 22 dD		20	27	dD -
(Uncorrected)	Pavg = 32 dBm	-	-30	-27	dBc

Test conditions unless otherwise noted: 25 °C, VDD=+28Vdc, IDQ=45 mA, Vgsp=Vgsm-0.5V, 1C-WCDMA 5MHz Signal, 7.6 dB PAR @ 0.01% CCDF test on WATECH Production Board

#### **Load Mismatch Test**

Condition	Test Result
VSWR=10:1, at all Phase Angles, VDD=28Vdc, IDQ = 25 mA,	
Vgsp=Vgsm-0.5V, 1C-WCDMA 5MHz Signal, 7.6 dB PAR @ 0.01% CCDF,	No Device
Frequency tested 3.5, 3.65 and 3.8 GHz	Degradation
PAVG = 35 dBm test on WATECH Application Board	2 cg. addi.orr

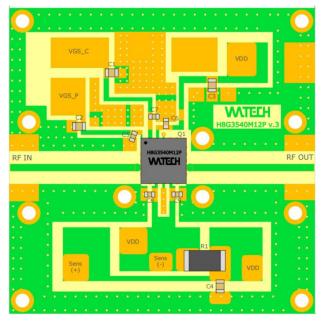
#### **Thermal Information**

Parameter	Condition	Value (Typ)	Unit
Thermal Resistance	TCASE= 90°C, 1C-WCDMA 5MHz	10	°C /W
Junction to Case (Rтн)	Signal, 7.6 dB PAR, Pavg = 32 dBm		67.11



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### H8G3540M12P 3.5 – 4.0 GHz Reference Design (47 x47 mm)



**EVB Layout** 

**EVB Schematic** 

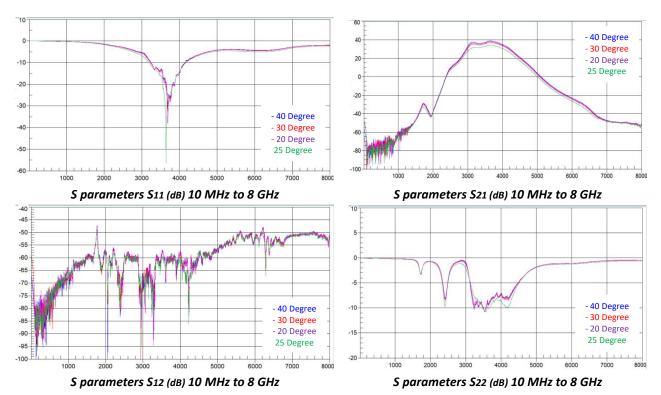
### Bill of Materials (BoM) - H8G3540M12P

### 3.5 - 4.0 GHz Reference Design

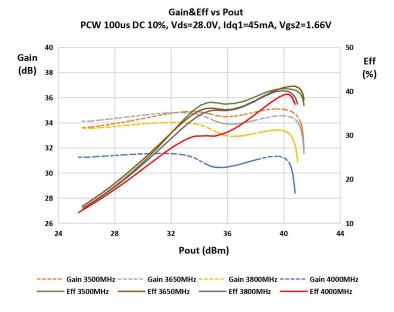
Reference	Value	Description	Manufacturer	P/N	
Q1		12W, 3.5-4 GHz LDMOS	Watech	H8G3540M12P	
Q1	-	MMIC PA	vvatecii	H6G534UWIZP	
C1 - C4	10uF ±10%,	Multi-Layer Ceramic	Murata	GRM21BB31C106KE15	
C1 - C4	0805	Capacitor	iviuiata	GMWZIDDJICIOOKLIJ	
C5 - C9	1uF ±10%, Multi-Layer Ceramic		Murata	GCM188R71E105KA64D	
C3 - C9	0603	Capacitor	iviuiata	GCW100K/1L103KA04D	
R1	$100$ m $\Omega/1$ W,	High-Precision Resistor	Vishay	Y44870R10000B0R	
IVI	0.1%				
	Rogers 4350B, er = 3.66; Thickness= 20 mil (0.508 mm); Thickness copper				
PCB	plating = 35 μm (1oz)				
	<ul> <li>Soldere</li> </ul>	ed on a 47x47x10 mm Copp	er Base-Plate		

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#### **Performance Plots**



Test conditions unless otherwise noted: 25 °C, VDD=+28Vdc, IDQ=45 mA, Vgsp=Vgsm-0.5V, S-Parameters test on WATECH Application Board



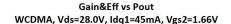
Pulsed CW, Gain and Efficiency vs Pout

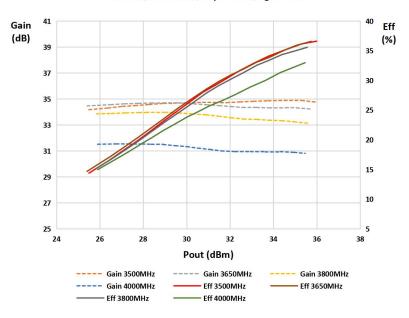
Test conditions unless otherwise noted:  $25 \,^{\circ}$ C, VDD = +28Vdc,  $IDQ = 45 \, mA$ , Vgsp = Vgsm-0.5V, Pulse Width =  $100 \, us$ , Duty Cycle = 10% test on WATECH Application Board



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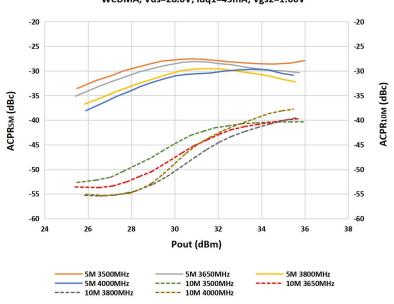




#### WCDMA, Gain and Efficiency vs Pout

Test conditions unless otherwise noted: 25 °C, VDD=+28Vdc, IDQ=45 mA, Vgsp=Vgsm-0.5V, 1C-WCDMA 5MHz Signal, 7.6 dB PAR @ 0.01% CCDF test on WATECH Application Board

## Max ACPR5M&10M vs Pout WCDMA, Vds=28.0V, Idq1=45mA, Vgs2=1.66V



#### WCDMA, ACPR 5MHz and 10MHz vs Pout

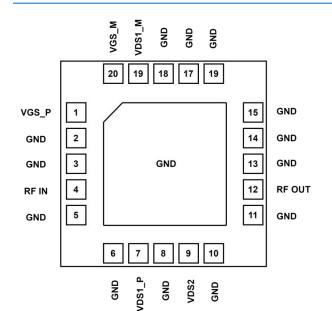
Test conditions unless otherwise noted: 25 °C, VDD=+28Vdc, IDQ=45 mA, Vgsp=Vgsm-0.5V, 1C-WCDMA 5MHz Signal, 7.6 dB PAR @ 0.01% CCDF test on WATECH Application Board



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### **Pin Configuration and Description**



15	GND	Ground	
16	GND	Ground	
17	GND	Ground	
18	GND	Ground	
19		Drain-Source	
	VDS1_M	Voltage Main	
		Driver	
20	Gate-Source		
	VGS_M	Voltage Main	

#### **Pinout Device Configuration**

Pin Number	Label	Description	
1	VCC D	Gate-Source	
1	VGS_P	Voltage Peak	
2	GND	Ground	
3	GND	Ground	
4	RFIN	RF Input	
5	GND	Ground	
6	GND	Ground	
		Drain-Source	
7	VDS1_P	Voltage Peak	
		Driver	
8	GND	Ground	
		Drain-Source	
9	VDS2	Voltage Final	
		Stage	
10	GND	Ground	
11	GND	Ground	
12	RFOUT	RF Output	
13	GND	Ground	
14	GND	Ground	



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#### **Package Marking and Dimensions**

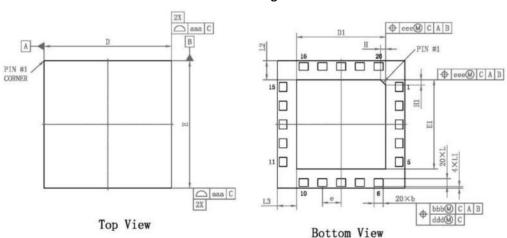


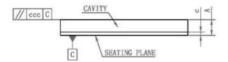
- Line1 (fixed): Device name in W/O
- Line2 (unfixed): Marking Lot No in W/O

(Sample: E596-20140001)

- Line3 (unfixed): Date Code + JY
- This Marking SPEC only stipulates the content of Marking. For marking requirements such as font and size, please refer to the latest version of "Watech Product Printing Specification"

#### Marking





Side View

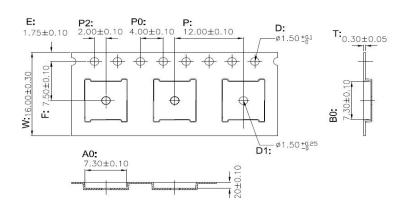
symbol	Dimension in mm			Dimension in inch		
	MIN	NOM	MAX	MIN	NOM	MAX
A	0.760	0.860	0.960	0.030	0.034	0.038
c	0.150	0.180	0.210	0.006	0.007	0.008
D	6, 900	7.000	7, 100	0.272	0.276	0.280
E	6.900	7.000	7.100	0.272	0.276	0. 280
DI	4.800	4.900	5.000	0.189	0.193	0. 197
EI	4.800	4. 900	5,000	0.189	0.193	0. 197
Н	-	0.286		_	0.011	_
H1	-	0.286	-	-	0.011	-
L	0.370	0.420	0.470	0.015	0.017	0.019
LI	0.025	0.100	0.175	0.001	0.004	0.007
1.2	0.975	1.050	1. 125	0.038	0.041	0.044
1.3	0.975	1.050	1. 125	0.038	0.041	0.044
e	-	1.030		-	0.041	-
ь	0.450	0.500	0, 550	0.018	0.020	0.022
888		0. 150			0.006	
bbb	0. 150		0.006			
coc	0.100		0.004			
ddd	0.080		0.003			
cec	0.150		0.006			

**Package Dimensions** 



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#### **Tape and Reel Information**



#### Notes:

- 1. Carrier tape color: BLACK.
- 2. Carrier material: PS (Polystyrene).
- 3. ESD surface resistivity < 1× 1011  $\Omega$ /square per EJA, JEDEC TNR specification.
- 4. Heat deflection temperature for Tape
- & Reel material: 62°C
- 5. Vicat softening temperature (10N) for Tape & Reel material: 95°C
- 6. Dimension is millimeter.

**Tape & Reel Packaging Descriptions** 

#### **Handling Precautions**

Parameter	Grade
Moisture Sensitivity Level MSL	3

Parameter	Rating	Standard
ESD – Human Body Model (HBM)	Class 1B	JESD22-A114
ESD – Human Body Model (MM)	Class A	EIA/JESD22-A115
ESD – Charged Device Model (CDM)	Class III	JESD22-C101



### **RoHS Compliance**

This product is compliant with the 2011/65/EU RoHS directive (Restrictions on the Use of Certain Hazardous Substances in Electrical and Electronic Equipment), as amended by Directive 2015/863/EU.

#### **Datasheet Status**

Document status	Product status	Definition
Objective Datasheet	Design simulation	Product objective specification
Preliminary Datasheet	Customer sample	Engineering samples and first test results
Product Datasheet	Mass production	Final product specification



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### **Abbreviations**

Acronym	Definition
LDMOS	Laterally-Diffused Metal-Oxide Semiconductor
CW	Continuous Waveform
VSWR	Voltage Standing Wave Ratio

### **Revision history**

Document ID	Datasheet Status	Release Date	Revision Version
Rev 1.1	Production	2021/07/15	First document version
Rev 1.2	Production	2021/07/19	Thermal resistance information
Rev 1.2	Production	2021/07/19	added
			Mass production data added,
Rev 1.3	Production	2021/07/30	typical and low/high thresholds
			data
Rev 1.4	Production	2023/01/03	New format based on English
			version datasheet



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For the latest specifications, additional product information, worldwide sales and distribution locations and information about WATECH:

• Web: www.watechelectronics.com

Email: MKT@huatai-elec.com

For technical questions and application information:

• Email: MKT@huatai-elec.com

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